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REVISIONS

DESCRIPTION

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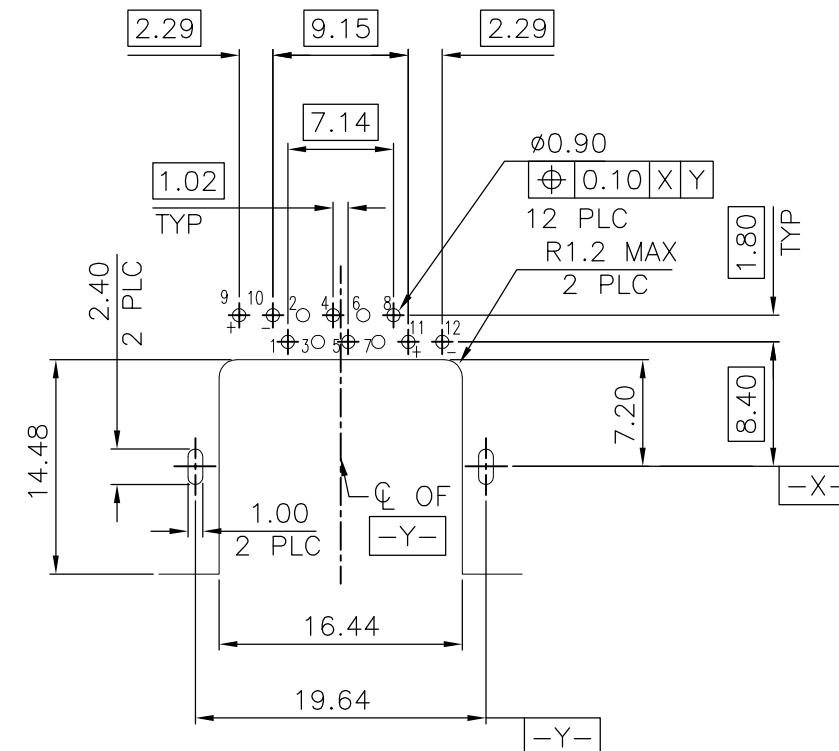
APVD

A5 | ECO-14-012616

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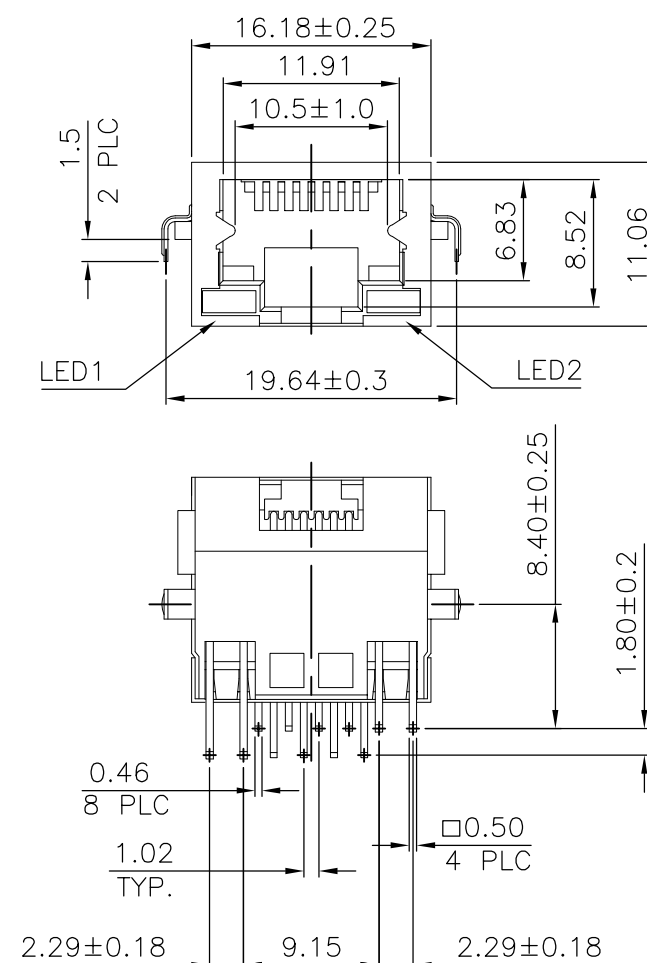
SH



RECOMMENDED PCB LAYOUT (THICKNESS: 1.6mm)

DIMENSION TOLERANCE: (1 PLC: ± 0.1 2PLC: ± 0.05)

6. OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI.



CUSTOMER DRAWING

SEE NOTE

SEE NOTE

STE

TE Connectivity

3	NAME
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MODULAR JACK, RJ45, SINGLE, SHIELD,
REVERSE, DIP TYPE

SIZE	
------	--

CAGE CODE

DRAWING NO

RESTRICTED TO

A.

00779

C-1734819

SCALE

	SHEET
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4. 1000000

REV Δ $\square$

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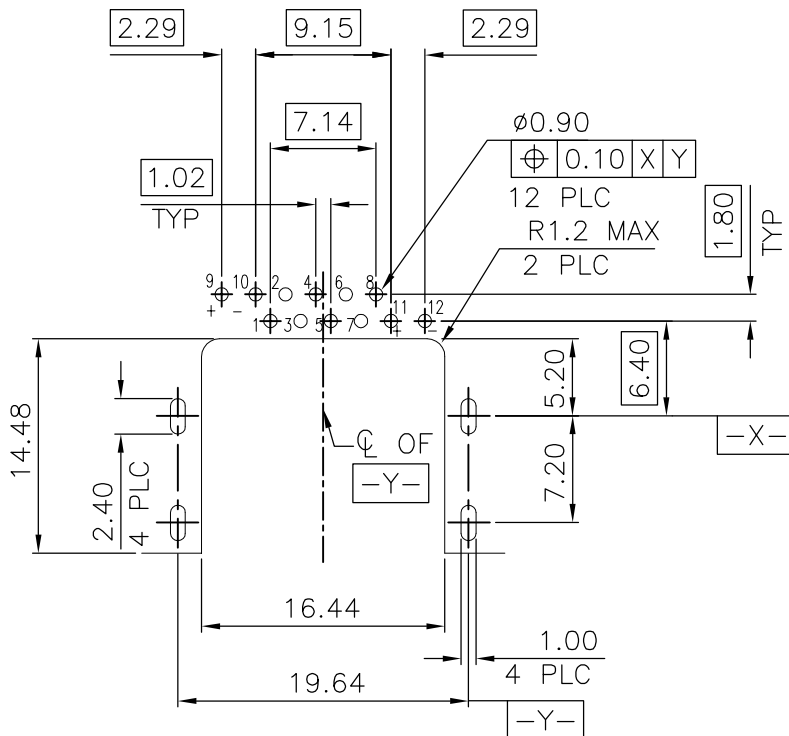
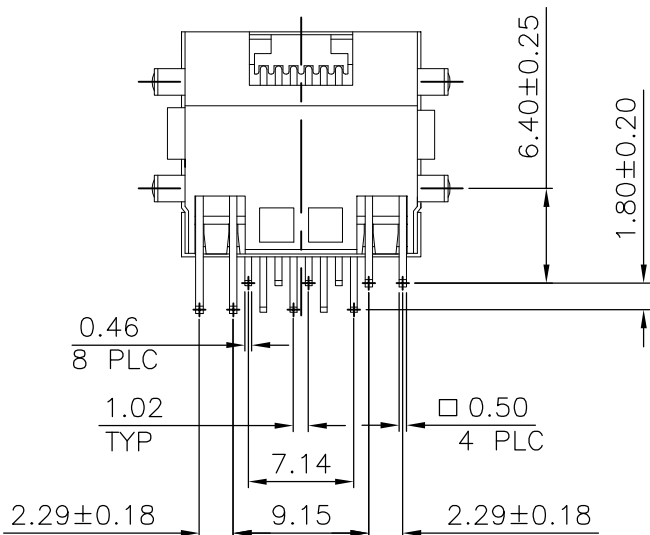
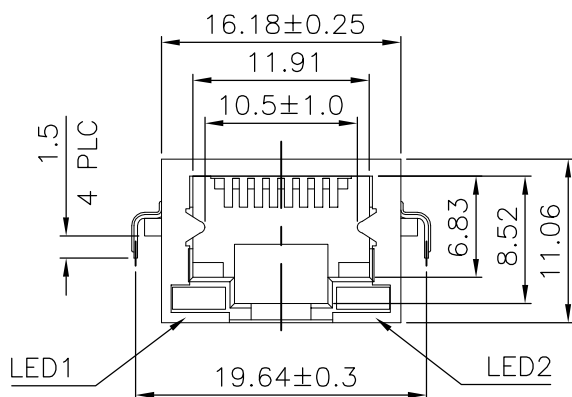
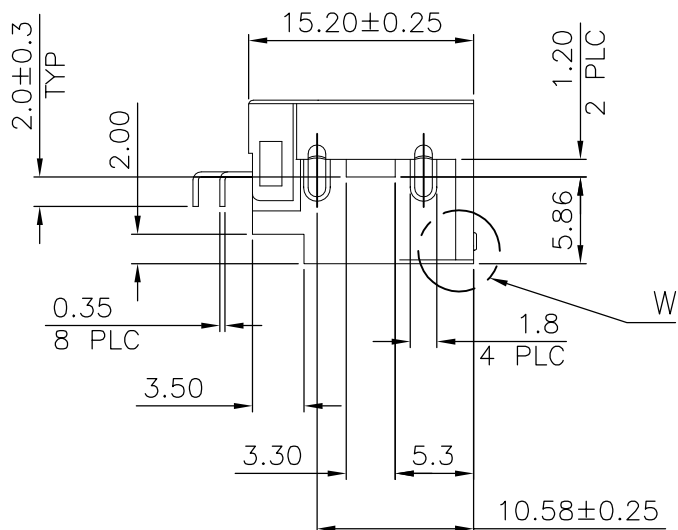
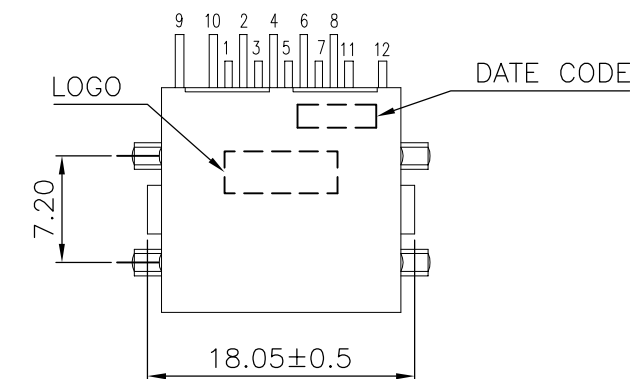
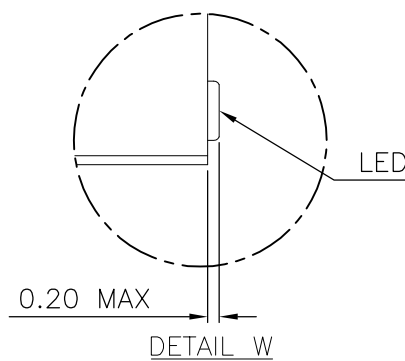
DESCRIPTION

DATE

DWN

APVD

SEE SHEET 1.



RECOMMENDED PCB LAYOUT (THICKNESS: 1.6mm)

DIMENSION TOLERANCE: (1 PLC: ±0.1 2PLC: ±0.05)

NOTE:

1. MATERIAL:

HOUSING: PA9T WITH 30% GF, UL94 V-0, BLACK COLOR.
CONTACTS: PHOSPHOR BRONZE.
SHELL: BRASS.
LED LIGHT: EPOXY RESIN.

2. FINISH:

CONTACTS: (SEE TABLE) GOLD PLATED ON CONTACT AREA,
GOLD FLASH ON SOLDER TAILS,
1.27µm [50µ"] MIN. NICKEL UNDERPLATED OVERALL.
SHELL: 0.508µm [20µ"] MIN. NICKEL PLATED.
LED LIGHT: 1.65µm [65µ"] MIN. Ag PLATED.
2.159µm [85µ"] MIN. TIN PLATED.

3. LED MUST BE REFLOW COMPATIBLE TO FOLLOWING TEMPERATURE
PROFILE (FOR 1 CYCLE): ABOVE 160 C FOR 120 SECONDS,
PEAKING AT 260 C FOR 10 SECONDS.

4. LED DEFECT RATE IS 6000 PPM MAX. AFTER IR REFLOW PROCESS
AS NOTE 3.

5. REFLOW SOLDER CAPABLE TO 260°C PER TE TEST SPEC.
109-201, CONDITION B.

⚠ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI.

OBSOLETE ⚠	REEL	YELLOW	GREEN	1.27μm [50μ"]	2=1734819=8
				0.762μm [30μ"]	2=1734819=7
				0.381μm [15μ"]	2=1734819=6
				0.152μm [6μ"]	2=1734819=5
	TRAY	YELLOW	GREEN	1.27μm [50μ"]	2=1734819=4
				0.762μm [30μ"]	2=1734819=3
				0.381μm [15μ"]	2=1734819=2
				0.152μm [6μ"]	2=1734819=1
PACKAGE	LED 2	LED 1	MIN. GOLD THICKNESS	PART NUMBER	
	INDICATOR COLOR				

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	TE Connectivity		
		CHK			
		APVD	NAME		
		PRODUCT SPEC			
		APPLICATION SPEC	MODULAR JACK, RJ45, SINGLE, SHIELD, REVERSE, DIP TYPE		
		WEIGHT			
CUSTOMER DRAWING		SCALE	SHEET		REV
			3 OF 6		A5

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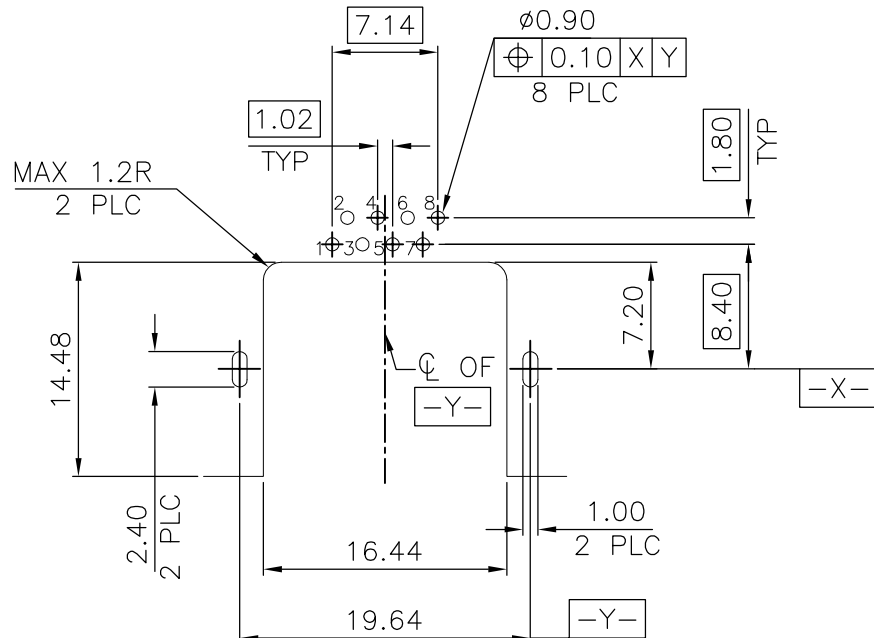
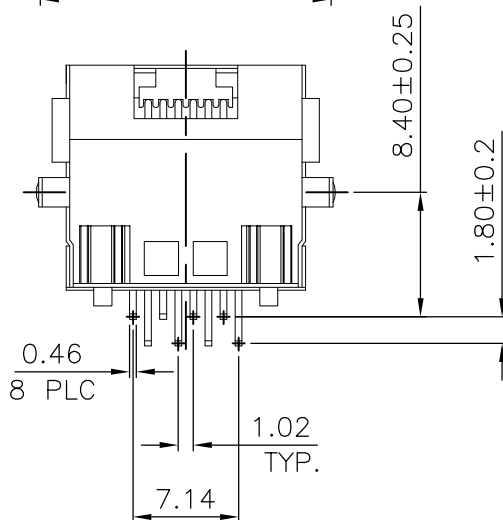
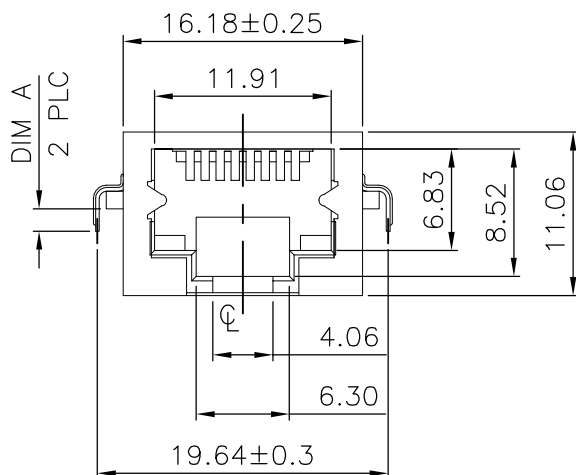
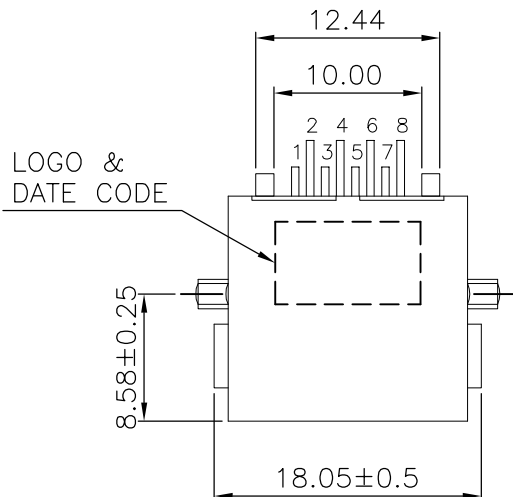
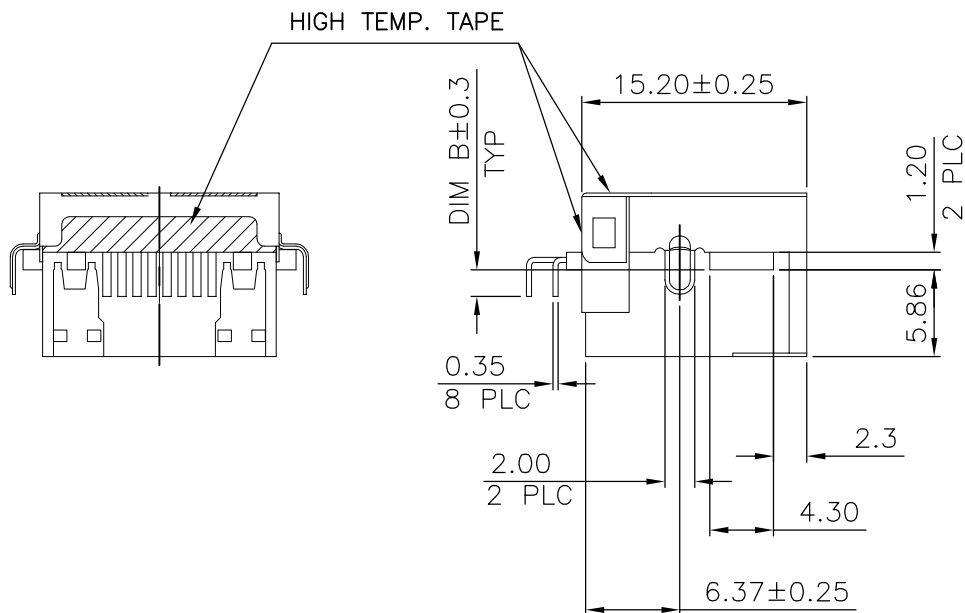
DESCRIPTION

DATE

DWN

APVD

SEE SHEET 1.



RECOMMENDED PCB LAYOUT (THICKNESS: SEE TABLE)
DIMENSION TOLERANCE: (1 PLC: ±0.1 2PLC: ±0.05)
TOP VIEW

NOTE:

- MATERIAL:
HOUSING: PA9T WITH 30% GF, UL94 V-0, BLACK COLOR.
CONTACTS: PHOSPHOR BRONZE.
SHELL: BRASS.
- FINISH:
CONTACTS: (SEE TABLE) GOLD PLATED ON CONTACT AREA,
GOLD FLASH ON SOLDER TAILS,
1.27µm [50µ"] MIN. NICKEL UNDERPLATED OVERALL.
SHELL: 0.508µm [20µ"] MIN. NICKEL PLATED.
- REFLOW SOLDER CAPABLE TO 260°C PER TE TEST SPEC.
109-201, CONDITION B.

	REEL	0.8	1.00	1.00	0.152μm [6μ"]	3-1734819-9
OBSOLETE		1.6	1.80	1.50	~~1.27μm [50μ"]~~	~~3-1734819-8~~
					~~0.762μm [30μ"]~~	~~3-1734819-7~~
					~~0.381μm [15μ"]~~	~~3-1734819-6~~
0.152μm [6μ"]	3-1734819-5					
OBSOLETE	TRAY				~~1.27μm [50μ"]~~	~~3-1734819-4~~
					~~0.762μm [30μ"]~~	~~3-1734819-3~~
					~~0.381μm [15μ"]~~	~~3-1734819-2~~
		~~0.152μm [6μ"]~~	~~3-1734819-1~~			
	PACKAGE	PCB THICKNESS	DIM B	DIM A	MIN. GOLD THICKNESS	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	TE Connectivity			
		CHK				
		APVD	NAME			
		PRODUCT SPEC				
		APPLICATION SPEC	MODULAR JACK, RJ45, SINGLE, SHIELD, REVERSE, DIP TYPE			
		WEIGHT				
DIMENSIONS: MM		TOLERANCES UNLESS OTHERWISE SPECIFIED:		SIZE	CAGE CODE	DRAWING NO
				A3	00779	C=1734819
				RESTRICTED TO		
MATERIAL		FINISH		SCALE		
SEE NOTE		SEE NOTE		SHEET 4 OF 6		
				REV A5		

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DESCRIPTION

DATE

DWN

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SEE SHEET 1.

D

D

C

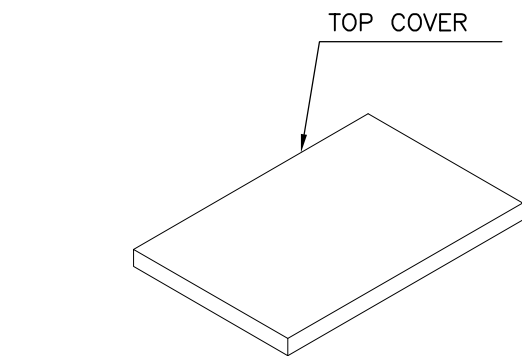
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B

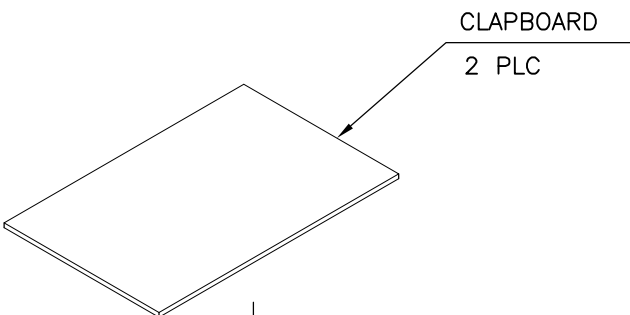
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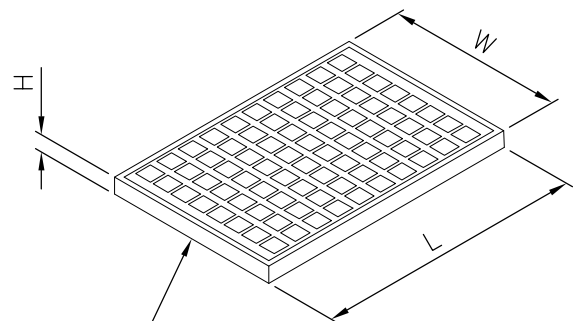
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TOP COVER

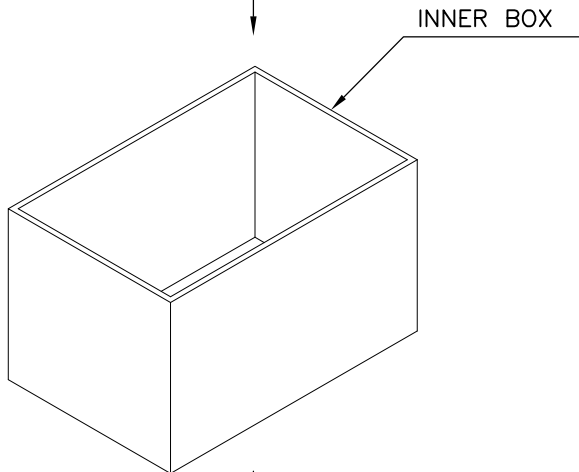


CLAPBOARD
2 PLC

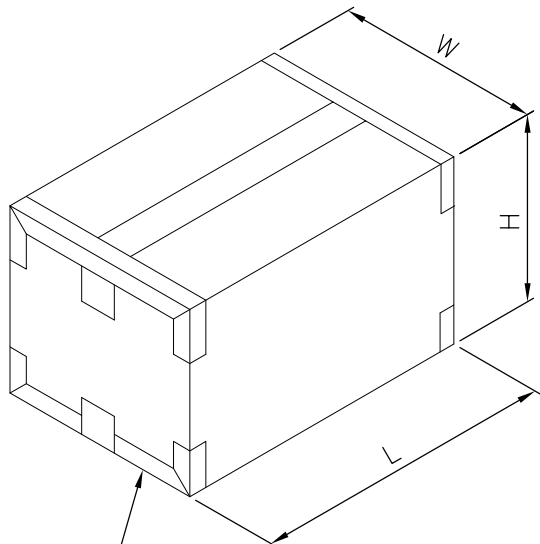


TRAY

330mm(L)X225mm(W)X15mm(H)

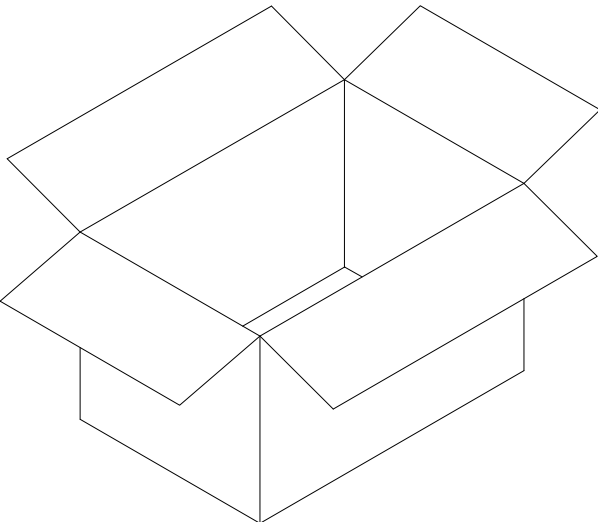
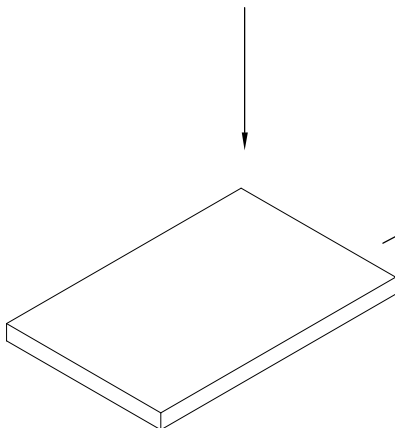


INNER BOX



BOX

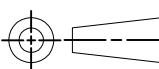
370mm(L)X255mm(W)X220mm(H)



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DIMENSIONS:

MM



MATERIAL

TOLERANCES UNLESS
OTHERWISE SPECIFIED:

0 PLC ± -
1 PLC ± -
2 PLC ± -
3 PLC ± -
4 PLC ± -
ANGLES ± -

FINISH

DWN

CHK

APVD

PRODUCT SPEC

APPLICATION SPEC

WEIGHT

CUSTOMER DRAWING

5.0Kg	2.8 Kg	80	11	880 PCS
GROSS WEIGHT (REF.)	NET WEIGHT (REF.)	PCS/TRAY	TRAYS/BOX	QUANTITY



TE Connectivity

NAME

MODULAR JACK, RJ45, SINGLE, SHIELD,
REVERSE, DIP TYPE

SIZE

CAGE CODE

DRAWING NO

RESTRICTED TO

A3

00779

C=1734819

SCALE

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SHEET

5 OF 6

REV

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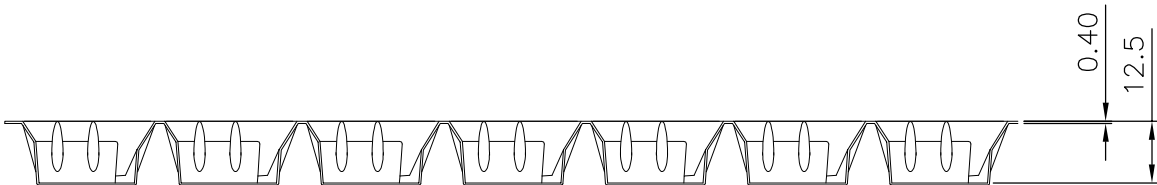
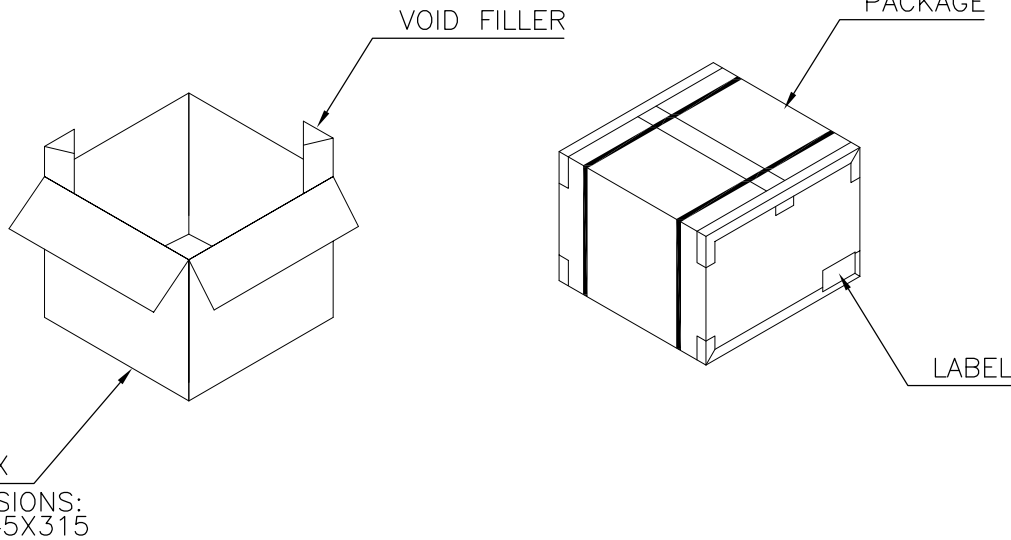
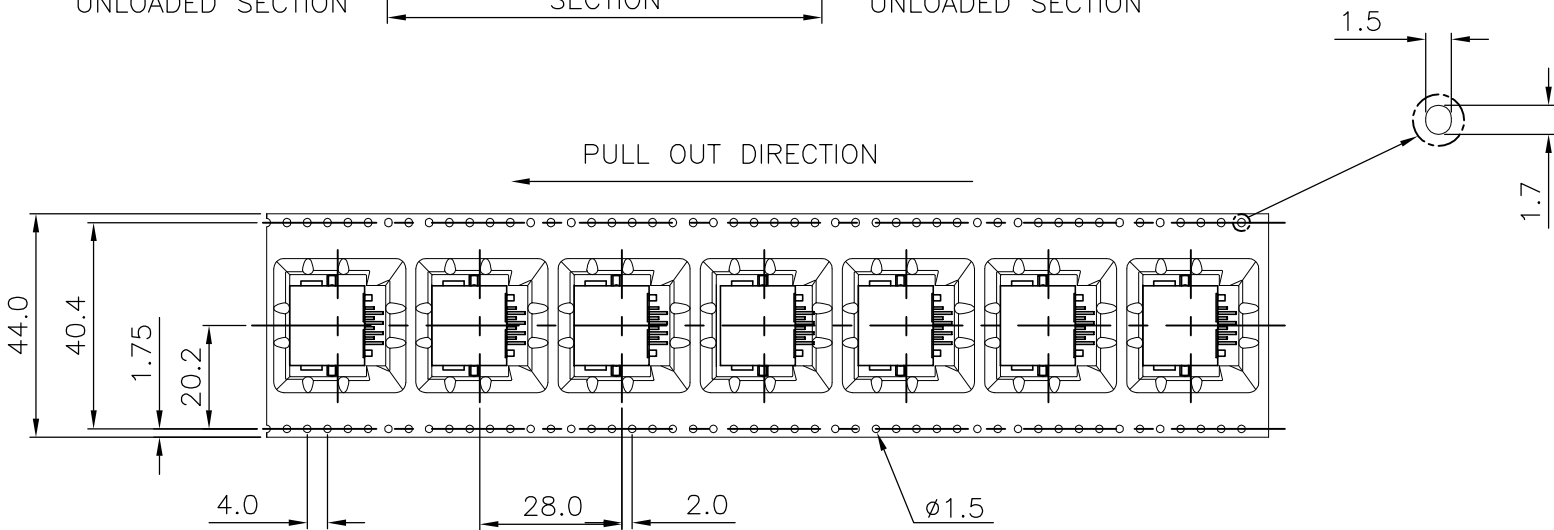
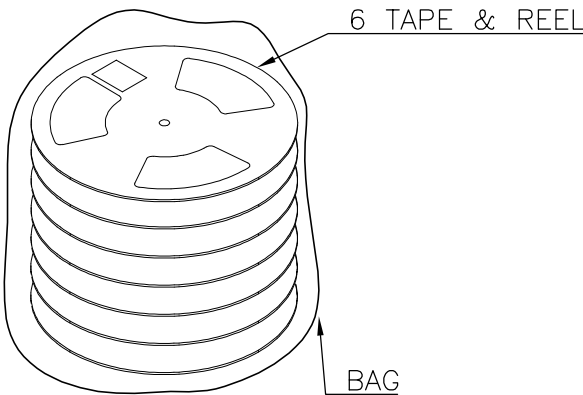
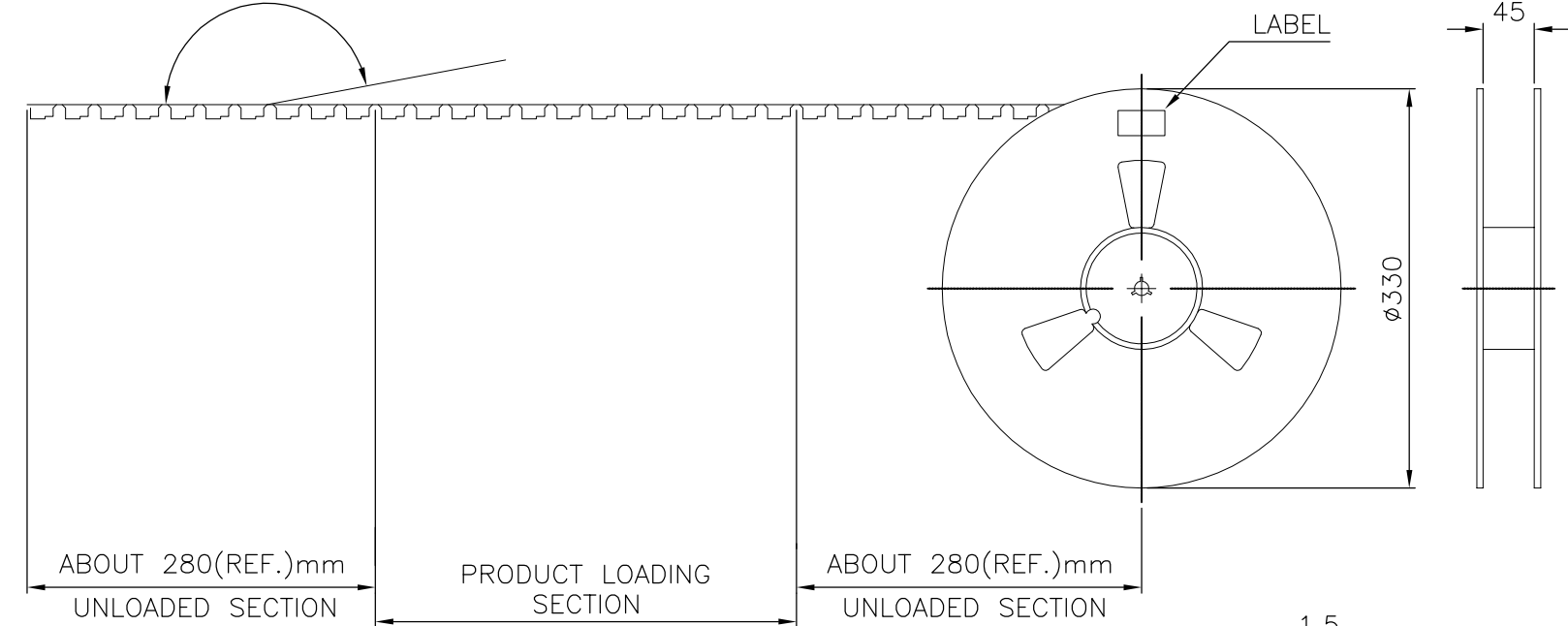
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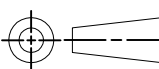
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LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
DW	—						
				SEE SHEET 1.			

PELLING ANGLE: 165°~180°



5.5 Kg	3.5 Kg	200	6	1200 PCS
GROSS WEIGHT (REF.)	NET WEIGHT (REF.)	PCS/REEL	REELS/BOX	QUANTITY

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	—	 TE Connectivity	
DIMENSIONS: MM		CHK	—		
		APVD	—	NAME	
		PRODUCT SPEC	—		
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APPLICATION SPEC	—	SIZE	
		WEIGHT	—		
MATERIAL		CUSTOMER DRAWING	SCALE	SHEET	REV
0 PLC ± — 1 PLC ± — 2 PLC ± — 3 PLC ± — 4 PLC ± — ANGLES ± — FINISH		A3	00779	DRAWING NO	RESTRICTED TO
		—	—	C=1734819	—
				6 OF 6	A5

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Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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